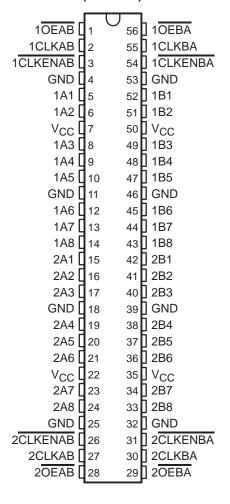
- Members of the Texas Instruments
  Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V<sub>OLP</sub> (Output Ground Bounce) < 1 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C
- Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Lavout
- High-Drive Outputs (-32-mA I<sub>OH</sub>, 64-mA I<sub>OI</sub>)
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

### description

The 'ABT16470 are 16-bit registered transceivers that contain two sets of D-type flip-flops for temporary storage of data flowing in either direction. The 'ABT16470 can be used as two 8-bit transceivers or one 16-bit transceiver. Separate clock (CLKAB or CLKBA) and output-enable (OEAB or OEBA) inputs are provided for each register to permit independent control in either direction of data flow.

To avoid false clocking of the flip-flops, clock enable (CLKEN) should not be switched from high to low while CLK is high.

SN54ABT16470 . . . WD PACKAGE SN74ABT16470 . . . DGG OR DL PACKAGE (TOP VIEW)



To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16470 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT16470 is characterized for operation from –40°C to 85°C.



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# SN54ABT16470, SN74ABT16470 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS SCBS085E - FEBRUARY 1991 - REVISED MAY 1997

### **FUNCTION TABLE**†

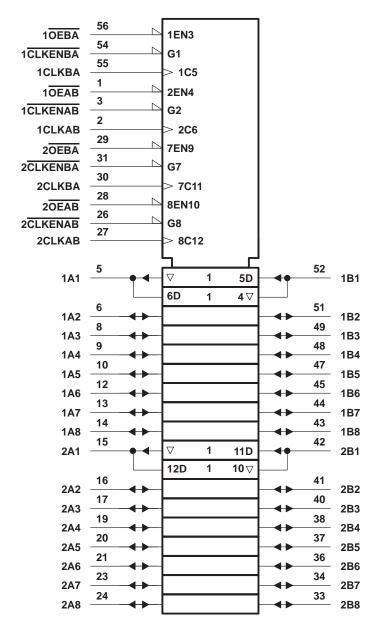
	OUTPUT			
CLKENAB	CLKAB	OEAB	Α	В
Н	Х	Χ	Χ	Z
Х	Χ	Н	Χ	Z
L	L	L	Χ	в <sub>0</sub> ‡
L	$\uparrow$	L	L	L
L	$\uparrow$	L	Н	Н

<sup>†</sup> A-to-B data flow is shown: B-to-A flow is similar but uses CLKENBA, CLKBA, and OEBA.



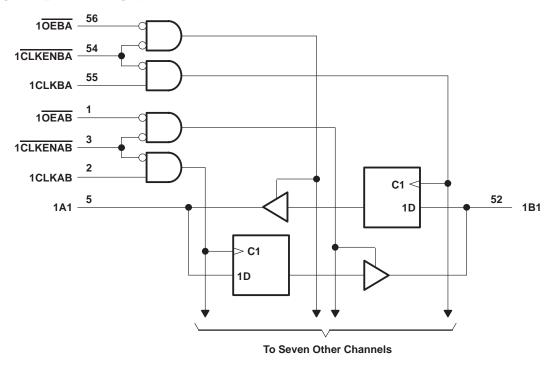
<sup>‡</sup>Output level before the indicated steady-state input conditions were established

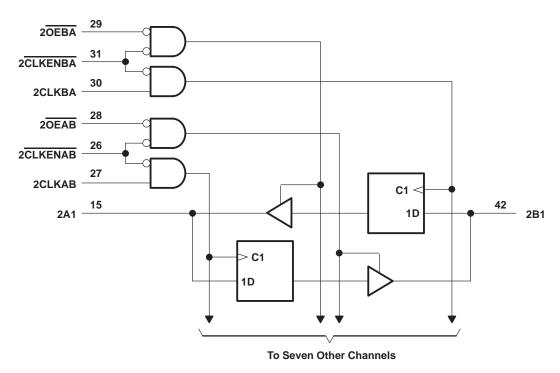
## logic symbol†



<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)







### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	–0.5 V to 7 V
Input voltage range, V <sub>I</sub> (except I/O ports) (see Note 1)	
Voltage range applied to any output in the high or power-off state, VO	–0.5 V to 5.5 V
Current into any output in the low state, I <sub>O</sub> : SN54ABT16470	96 mA
SN74ABT16470	128 mA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DGG package	
DL package	
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions (see Note 3)

			SN54ABT	16470	SN74ABT	16470	UNIT
			MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2	EM	2		V	
VIL	Low-level input voltage		0.8		0.8	V	
٧ <sub>I</sub>	Input voltage		0 0	VCC	0	VCC	V
loh	High-level output current		40,	-24		-32	mA
loL	Low-level output current	200	48		64	mA	
Δt/Δν	Input transition rise or fall rate	Outputs enabled	B	10		10	ns/V
TA	Operating free-air temperature		<b>–</b> 55	125	-40	85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

<sup>2.</sup> The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

### SN54ABT16470, SN74ABT16470 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS085E - FEBRUARY 1991 - REVISED MAY 1997

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST COM	IDITIONS	Т	A = 25°C	;	SN54AB	Γ16470	SN74AB1	Γ16470	UNIT	
PA	RAWETER	1EST COR	ADITIONS	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII	
VIK		$V_{CC} = 4.5 \text{ V},$	I <sub>I</sub> = -18 mA			-1.2		-1.2		-1.2	V	
		$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -3 \text{ mA}$	2.5			2.5		2.5			
\/a		$V_{CC} = 5 V$ ,	$I_{OH} = -3 \text{ mA}$	3			3		3		V	
VOH		V <sub>CC</sub> = 4.5 V	$I_{OH} = -24 \text{ mA}$	2			2				v	
		VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$	2*					2			
Val		V <sub>CC</sub> = 4.5 V	$I_{OL} = 48 \text{ mA}$			0.55		0.55			V	
VOL		VCC = 4.5 V	$I_{OL} = 64 \text{ mA}$			0.55*				0.55	V	
V <sub>hys</sub>					100			14			mV	
١.	Control inputs	V <sub>CC</sub> = 5.5 V,			±1		₹ ±1		±1			
tı	A or B ports $VCC = 5.5 \text{ V},$		$V_I = V_{CC}$ or GND			±100	4	±100		±100	μΑ	
lozh <sup>‡</sup>		$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 2.7 V			50		50		50	μΑ	
loz <sub>L</sub> ‡		$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 0.5 V			-50	<sup>2</sup> QC	<b>-</b> 50		-50	μΑ	
loff		$V_{CC} = 0$ ,	$V_I$ or $V_O \le 4.5 \text{ V}$			±100	4			±100	μΑ	
ICEX		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V	Outputs high			50		50		50	μА	
IO§		V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.5 V	-50	-100	-200	-50	-200	-50	-200	mA	
		V <sub>CC</sub> = 5.5 V,	Outputs high			2		2		2		
Icc	A or B ports	$I_O = 0$ ,	Outputs low			35		35		35	mA	
		$V_I = V_{CC}$ or GND	Outputs disabled			2		2		2		
		V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND				0.5		0.5		0.5	mA	
Ci	Control inputs	V <sub>I</sub> = 2.5 V or 0.5 V			3						pF	
Cio	A or B ports	$V_0 = 2.5 \text{ V or } 0.5 \text{ V}$			8.5						pF	

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter does not apply.

## timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

		V <sub>CC</sub> =	= 5 V, 25°C	SN54AB	T16470	SN74AB1	16470	UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
fclock	Clock frequency	0	150	0	150	0	150	MHz
t <sub>W</sub> #	Pulse duration, CLKAB or CLKBA high or low	3.3		3.3	16.10	3.3		ns
t <sub>su</sub>	Setup time, data before CLKAB↑ or CLKBA↑	4		4	7.	4		ns
th	Hold time, data after CLKAB↑ or CLKBA↑	1		Ŷ1		1		ns

<sup>#</sup>This parameter is characterized, but not production tested.



<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ .

<sup>&</sup>lt;sup>‡</sup> The parameters IOZH and IOZL include the input leakage current.

<sup>§</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

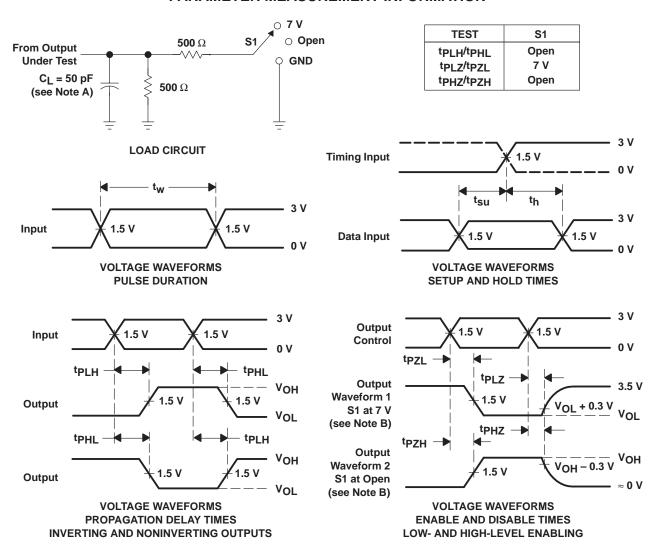
## SN54ABT16470, SN74ABT16470 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS085E - FEBRUARY 1991 - REVISED MAY 1997

# switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>(</sub>	CC = 5 V 4 = 25°C	', ;	SN54AB	Γ16470	SN74AB1	Γ16470	UNIT
	(1141 01)	(0011 01)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f <sub>max</sub>			150			150		150		MHz
<sup>t</sup> PLH	CLK	A or B	1.4	3.1	4.8	1.4	5.1	1.4	4.9	
<sup>t</sup> PHL	CLK	AUIB	1.3	3.2	4.6	1.3	5.1	1.3	4.9	ns
<sup>t</sup> PZH	ŌĒ	A or B	1	3.1	4.3	1	5	1	4.9	20
t <sub>PZL</sub>	OE.	AUID	1.2	3.6	5.8	1.2	6.9	1.2	6.8	ns
<sup>t</sup> PHZ	ŌĒ	A or B	1.9	3.7	4.9	1.9	6	1.9	5.5	
t <sub>PLZ</sub>	OE OE	AOIB	1.6	3.3	4.8	1.6	5.4	1.6	5.3	ns
<sup>t</sup> PZH	- OLIVEN	A or B	1	3.4	4.6	& 1	5.8	1	5.7	
t <sub>PZL</sub>	CLKEN	AUIB	1.2	3.9	6	1.2	7.3	1.2	7.2	ns
<sup>t</sup> PHZ	CLKEN	A or B	1.7	3.9	5.2	1.7	6.2	1.7	5.8	no
<sup>t</sup> PLZ	CLKEN	AOLR	1.5	3.6	5.3	1.5	5.5	1.5	5.4	ns

### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_{Q}$  = 50  $\Omega$ ,  $t_{f}$   $\leq$  2.5 ns,  $t_{f}$   $\leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



### \*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT16470DGGR	TSSOP	DGG	56	2000	330.0	24.4	8.6	15.6	1.8	12.0	24.0	Q1
SN74ABT16470DLR	SSOP	DL	56	1000	330.0	32.4	11.35	18.67	3.1	16.0	32.0	Q1





\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABT16470DGGR	TSSOP	DGG	56	2000	346.0	346.0	41.0
SN74ABT16470DLR	SSOP	DL	56	1000	346.0	346.0	49.0

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